# Integrated Multi-Channel DC/DC Converter for TFT LCD Panels

## **General Description**

The RT9921 includes a high-performance boost regulator, a low dropout linear regulator (LDO), a gate pulse modulator (GPM), a voltage detector, a VCOM buffer (unitygain OPA), and a VGH charge pump controller for activematrix thin-film transistor (TFT) liquid-crystal displays (LCDs).

The boost converter provides the regulated supply voltage for the panel source driver ICs. The converter is a high switching frequency (640kHz or 1.2MHz) current-mode regulator with an integrated 16VN-Channel 0.2 $\Omega$  MOSFET that allows the use of ultra-small inductors and ceramic capacitors. It provides fast transient response to pulsed loading while achieving efficiency over 90%. The device can produce output voltage as high as 15V from an input as low as 2.5V. Soft-Start is programmed by external capacitor, which sets the input-current ramp-rate.

The low-dropout (LDO) linear regulator can supply up to 350mA current while input voltage is 3.3V. It uses an internal P-MOSFET as the pass device. It is suitable for the supply voltage of the timing controller.

The GPM is controlled by frame signals from timing controller to modulate the Gate-On voltage, VGHM, which acts a flicker compensation circuit to reduce the coupling effect between gate lines and pixels. It also can delay the Gate-On voltage while power-on for achieving a corrected power-on sequence for gate driver ICs. Both of power-on delay time and the falling time of the Gate-On voltage are programmable by external capacitor and resistor.

The voltage detector monitors the supply voltage to issue a reset signal while the detected voltage is too low. The detecting level is decided by an external resistor divider and the delay time is programmable by an external capacitor.

The VCOM buffer can drive the LCD VCOM voltage that features high short-circuit current (140mA), fast slew rate (12V/ $\mu$ s), wide bandwidth (12MHz) and rail-to-rail inputs and outputs.

The VGH charge pump controller provides regulated TFT Gate-On voltage. The regulation of the positive charge pump is generated by the internal comparator that senses the output voltage and compares it with an internal reference.

### Features

- 2.5V to 5.5V Input Supply Voltage
- 640kHz/1.2MHz Current-Mode Boost Regulator
  - Fast Transient Response to Pulsed Load
  - Adjustable Output Voltage (±1%)
  - Built-In 16V, 2A, 0.2Ω N-MOSFET
  - High Efficiency Up to 90%
  - Programmable Soft-Start
  - Over-Current Protection
  - Output Under-Voltage Protection
- Low Dropout Voltage Linear Regulator
  Adjustable Output Voltage : 1.5V to V<sub>IN</sub> 0.5V
  - (±1.5%) Adjustable Output voltage : 1.5V to  $V_{IN} = 0.5V$
  - Maximum Output Current : 350mA
- On-Chip GPM Controller with Adjustable
  - Falling Time and Power-On Delay
  - Flicker Compensator
  - Power-On Sequence Control
- Low Voltage Detector
  Programmable Detecting Voltage (±2%) and Delay Time
- Unity-Gain Operation Amplifier for VCOM Buffer
- Charge Pump for VGH regulation
- Over-Temperature Protection
- Thin 24 Lead VQFN Package
- RoHS Compliant and 100% Lead (Pb)-Free

### **Marking Information**

For marking information, contact our sales representative directly or through a Richtek distributor located in your area.



### **Ordering Information**

#### RT9921 🗖 📮

Package Type QV : VQFN-24L 4x4 (V-Type) (Exposed Pad-Option 2) Lead Plating System P : Pb Free G : Green (Halogen Free and Pb Free)

Note :

Richtek products are :

- RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- Suitable for use in SnPb or Pb-free soldering processes.

#### **Pin Configurations** (TOP VIEW) COMP PGND FREQ OPAO OPAI B 24 23 20 22 21 19 LX 18 AVDD 1 17 DRVP VIN 2 FBP SS 3 16 AGND AGND 4 15 VGH 5 14 VGHM ADJ 6 13 RE LDOO 12 8 10 11 9 VFLK /DPM RESET 8 ð

#### VQFN-24L 4x4



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# **Typical Application Circuit**

# **Functional Pin Description**

Pin No.	Pin Name	Pin Function
1	LX	Switching Pin. Drain of the internal power N-MOSFET for the main step-up regulator.
2	VIN	Supply Input. The supply voltage powers all the control circuits including the boost converter, negative linear-regulator and gate pulse regulator and voltage detector.
3	SS	Soft-Start Control Pin. Connect a soft-start capacitor ( $C_{SS}$ ) to this pin. The soft-start capacitor is charged with a constant current $4\mu A$ .
4, 25 (Exposed Pad)	AGND	Analog Ground. The exposed pad must be soldered to a large PCB and connected to GND for maximum power dissipation.
5	ADJ	Low Dropout Linear Regulator (LDO) Feedback Input. ADJ regulates to 1.24V nominal. Connect ADJ to the center of a resistive voltage divider between the LDO output voltage LDOO and the analog ground (AGND) the LDO output voltage. Place the resistive voltage divider close to the pin.
6	LDOO	Voltage Output of the LDO.
7	LDOI	Voltage Input for the LDO.
8	VDIV	Voltage Detector Divider Input. Connect VDIV to the center of a resistive voltage-divider between the detected voltage input (VDI) and analog ground (AGND).
9	RESET	Voltage Detector Output for Reset. Active Low.
10	CD	Pin for external capacitor setting the delay time for voltage detector reset delay time. The delay time $t_D = 120k \times C_D$ sec, where $C_D$ is the capacitance value.
11	VDPM	High-Voltage Switch Delay Input. Connect a capacitor from VDPM to GND to set the delay time. A $20\mu$ A current source charges C <sub>DPM</sub> . Power on delay time = 62k x C <sub>DPM</sub> .
12	VFLK	VFLK is produced by timing controller for charging or discharging VGHM.
13	RE	Switch Input for Discharge VGHM.
14	VGHM	VGHM is the Supply Voltage for the Gate Driver ICs.
15	VGH	Switch Input for Charge VGHM.
16	FBP	Voltage Feedback to Determine Gate-High Regulator's Output Voltage. Connect FBP to the center of a resistive voltage-divider between the output voltage VGH and GND. Place the resistive voltage-divider close to the pin.
17	DRVP	Voltage Driver Output of Gate-High Regulator.
18	AVDD	VDD for Source Driver Power. This also supplies the GPM/OPA block.
19	OPAO	Unity-Gain OPA output pin.
20	OPAI	Unity-Gain OPA input Pin.
21	COMP	Compensation Pin for Error Amplifier. Connect a compensation network to ground.
22	FB	Main Boost Regulator Feedback Input. FB regulates to 1.24V nominal. Connect FB to the center of a resistive voltage-divider between the main output AVDD and the analog ground (AGND) the boost regulator output voltage. Place the resistive voltage divider close to the pin.
23	FREQ	Boost Converter Frequency Select Input. When FREQ is low, the oscillator frequency is set to 640kHz. When FREQ is high, the frequency is 1.2MHz. This input has a $5\mu$ A pull-down current.
24	PGND	Power Ground. PGND is the source of the power N-MOSFET. Connect PGND to the analog ground (AGND) at the device's pins.



# **Function Block Diagram**



# Absolute Maximum Ratings (Note 1)

Supply Input Voltage, V <sub>IN</sub>	
• LX	
• VGH, VGHM, RE	
• AVDD	
• VGH – AVDD, VGHM – AVDD	
• OPAI, OPAO, DRVP	
• VDPM, VFLK, CD, RESET, VDIV, SS, COMP, FB, FBP	
• LDOI	
• ADJ, LDOO	
• Power Dissipation, $P_D @ T_A = 25^{\circ}C$	
VQFN-24L4x4	1.786W
Package Thermal Resistance (Note 2)	
VQFN-24L 4x4, θ <sub>JA</sub>	56°C/W
• Lead Temperature (Soldering, 10 sec.)	260°C
Junction Temperature	150°C
Storage Temperature Range	
ESD Susceptibility (Note 3)	
HBM (Human Body Mode)	2kV
MM (Machine Mode)	200V

# Recommended Operating Conditions (Note 4)

Maximum Output Voltage Setting, AVDD and VOUT	15V
Maximum (VGH - AVDD)	18V
Junction Temperature Range	
Ambient Temperature Range	40°C to 85°C

### **Electrical Characteristics**

(V\_{IN} = 3.3V, V\_{OUT} = 8.5V, T\_A = 25^{\circ}C, unless otherwise specification)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit			
System Supply									
Input Supply Voltage	V <sub>IN</sub>		2.5		5.5	V			
V <sub>IN</sub> Under Voltage Lockout	V <sub>UVLO</sub>	V <sub>IN</sub> Rising	1.8	2	2.2	V			
Threshold		Hysteresis		0.1					
V. Ouiopoont Current	l <sub>Q</sub>	V <sub>FB</sub> = 1.3V, LX no Switching		0.5	1	mA			
		V <sub>FB</sub> = 1.1V, LX Switching		2	4	mA			
Shutdown Current	I <sub>SHDN</sub>	V <sub>IN</sub> = 3.3V	-	1	5	μA			
Main Boost Regulator									
Operation Frequency	fosc	FREQ = 0	1	640	1	kHz			
Operation Frequency		FREQ = V <sub>IN</sub>	1	1.2	1.5	MHz			
Maximum Duty Cycle			86	90		%			

# **RT9921**



Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
FREQ Input Low Voltage				-	0.3 x V <sub>IN</sub>	V	
FREQ Input High Voltage			0.7 x V <sub>IN</sub>			V	
FREQ Pull-down Current		V <sub>FREQ</sub> = 1.0V		4		μA	
Feedback Voltage	V <sub>FB</sub>	No Load	1.228	1.240	1.252	V	
FB Input Bias Current		V <sub>FB</sub> = 1.5V	-40		+40	nA	
Transconductance of Error Amplifier	Gm	I <sub>COMP</sub> = 5μA		160		μA/V	
Voltage Gain of Error Amplifier	AV			700		V/V	
Feedback Voltage Line Regulation		V <sub>IN</sub> = 2.5 to 5.5V		-0.1		%/V	
LX ON-Resistance	R <sub>LX(ON)</sub>			200	500	mΩ	
LX Current Limit	ILIM			2.0		А	
Current Sense Transresistance				0.5		A/V	
Soft-Start Charge Current	I <sub>SS</sub>			4		μA	
Thermal Shutdown Temperature	T <sub>SD</sub>			170		°C	
Thermal Shutdown Hysteresis	$\Delta T_{SD}$			20		°C	
FB Fault Trip Level (UVP Level)		V <sub>FB</sub> Falling		1.05		V	
FB Fault Delay (UVP Delay)				160		ms	
Low Dropout Linear Regulator (LD	00)						
Input Voltage	V <sub>LDOI</sub>		2.5		5.5	V	
Dropout Voltage	Vdrop	V <sub>IN</sub> = 3.3V, I <sub>OUT</sub> = 350mA		450	500	mV	
Feedback Voltage	Vadj		1.224	1.240	1.256	V	
Current Limit	I <sub>LIM</sub>		350	500		mA	
Quiescent Current	ILDO			90		μA	
Line Regulation		$V_{IN} = 2.8$ to 5.5V, I <sub>OUT</sub> = 100mA, $V_{LDO} = 2.5V$		0.1	0.3	%/V	
Load Regulation		I <sub>OUT</sub> = 1mA to 300mA	-	0.2	0.5	%	
Gate Pulse Modulator							
VFLK Input High Voltage	V <sub>IH_FLK</sub>		1.5			V	
VFLK Input Low Voltage	VIL FLK				0.6	V	
Charge Current of VDPM Pin	I <sub>1</sub>		18	20	22	μA	
VGH Switch On-Resistance	RP1			30		Ω	
RE Switch On-Resistance	RN2			25		Ω	
Voltage Detector							
Minimum Operating Voltage			1.6			V	
Detecting Voltage Adjustment	VDIV			1.1		V	
Detecting Voltage Accuracy			-2%		2%	%	
Adjustable Delay Time-Constant	k	$t_D = k(\Omega) \times C_D(F)$		120k		Ω	

Parameter	Symbol	Test	Condition	Min	Тур	Max	Unit	
VCOM Buffer								
Supply Voltage Range				AVDD		15	V	
Supply Current	I <sub>OP</sub>				0.8	1.5	mA	
Input Offset Voltage	Vos	$V_{COM} = AVD$	D/2, T <sub>A</sub> = 25°C	-17		17	mV	
Input Bias Current	IBIAS				1	50	nA	
Output Valtere Outpart Link	Maria	Ιουτ = 100μΑ		AVDD –20	AVDD -5		mV	
Output voltage Swing High	VOH	I <sub>OUT</sub> = 75mA			AVDD -1.5		V	
Output Valte as Outing Law	V <sub>OL</sub>	I <sub>OUT</sub> = -100μA			5	20	mV	
Output voltage Swing Low		I <sub>OUT</sub> = -75mA			1.5		V	
Oh ant Oinswit Oursant		To AVDD/2	Source	100	180	230	mA	
Snort-Circuit Current			Sink	100	180	230	mA	
-3dB Bandwidth	F <sub>3dB</sub>				12	I	MHz	
Gain Bandwidth Product	GBW				8		MHz	
Slew Rate SR					12		V/µs	
Gate-High Regulator								
Feedback Reference Voltage V <sub>FB</sub>		No Load		1.216	1.240	1.264	V	
DDV/D Switch On Desistance	R <sub>ON_P</sub>	V <sub>AVDD</sub> = 12V			20		Ω	
DRVP Switch On-Resistance	R <sub>ON_N</sub>	V <sub>AVDD</sub> = 12V			20		Ω	
Switching Frequency f <sub>SW</sub>			0.5 x f <sub>OSC</sub>					

**Note 1.** Stresses listed as the above "Absolute Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.

Note 2.  $\theta_{JA}$  is measured in the natural convection at  $T_A = 25^{\circ}C$  on a high effective thermal conductivity test board of JEDEC 51-7 thermal measurement standard.

- Note 3. Devices are ESD sensitive. Handling precaution is recommended.
- Note 4. The device is not guaranteed to function outside its operating conditions.

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## **Typical Operating Characteristics**











LDO Output Voltage vs. Output Current



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Time (2.5µs/Div)

Time (250ns/Div)

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### **Application Information**

The RT9921 contains a high performance boost regulator to generate voltage for output voltage, gate-on driver and gate-off driver. It also includes of a high-current rail-to rail operation amplifier, a gate pulse modulator (GPM), a programmable timing control voltage detector, and a low dropout linear regulator. The following content contains the detailed description and the information of the component selection.

#### **Boost Regulator**

The boost regulator is a high efficiency current-mode PWM architecture with 640k / 1.2MHz operation frequency. It performs fast transient responses to generate source driver supplies for TFT LCD display. The high operation frequency allows smaller components to minimize the thickness of LCD panel. To regulate the output voltage is to set resistive voltage-divider sensing at FB pin. The error amplifier varies the COMP voltage by sensing the FB pin to regulate the output voltage. For better stability, the slope compensation signal that combined with the current-sense signal will be compared with the COMP voltage to determine the current trip point and duty cycle.

#### Soft-Start

The RT9921 provides soft-start function to minimize the inrush current. When power on, an internal constant current charges an external capacitor. The rising voltage rate on COMP pin will be limited during the charging period and the inductor peak current will also be limited at the same time. In the meanwhile, the frequency increases slowly at the beginning. When power off, the external capacitor will be discharged for next soft start time.

The soft-start function is implemented by the external capacitor with a 4uA constant current charging to the softstart capacitor. Therefore, the capacitor should be large enough for output voltage regulation. Typical value for softstart capacitor range is 27nF. The available soft start capacitor range is from 10nF to 100nF.

#### **Output Voltage**

The regulated output voltage is calculated by the following formula :

 $V_{OUT} = VFB \times \left(1 + \frac{R1}{R2}\right)$ , where  $V_{FB} = 1.24V$  (typ.)

The recommended value for R2 should be up to  $100k\Omega$  without some sacrificing. To place the resistor-divider as close as possible to the chip can reduce noise sensitivity.

#### Loop Compensation

The voltage feedback loop can be compensated with an external compensation network consisted of R3, C3 (As Figure 1). Choosing R3 to set high frequency integrator gain for fast transient response and C3 to set the integrator zero to maintain loop stability. For typical application  $V_{IN} = 3.3V$ ,  $V_{OUT} = 8.5V$ ,  $C_{OUT} = 4.7 \mu F \times 3$ ,  $L = 4.7 \mu H$ , the recommened value for compensation is as below : R3 = 56k $\Omega$ , C3 = 1nF.

#### **Over Current Protection**

The RT9921 main boost converter has the function of overcurrent from protection to limit peak inductor current. It prevents large current damaging the inductor and diode. During the ON-time, once the inductor current exceeds the current limit, the internal LX switch turns off immediately and shortens the duty cycle. Therefore, the output voltage drops if the over-current condition occurs. Actual current limit is always larger than the nominal value because of the internal circuit delay. Current limit is also affected by the input voltage, duty cycle, and inductor value.

#### **Over Temperature Protection**

The RT9921 main boost converter has thermal protection function to prevent the excessive power dissipation from overheating. When the junction temperature exceeds 170°C, it will shut down the device. Once the device cools down by approximately 20°C, it will start to operate normally. For continuous operation, do not operate over the maximum junction temperature rating around 150°C.

#### **Under Voltage Protection**

If the boost regulator feedback voltage is under 90% of the nominal value, the RT9921 activates an internal timer. If the fault condition continues for 160ms, the PWM will latch off and won't restart until VIN power is cycled. The under-voltage protection is disabled during the soft-start time.

#### **Inductor Selection**

The minimum inductance value, peak current rating and series resistance are factors to be considered in the inductor selecting process. These factors will affect the converter efficiency, maximum output load capability, transient response time and output voltage ripple. Physical size and cost are also important factors to be considered.

The maximum output current, input voltage, output voltage and switching frequency will determine the inductor value. Very high inductance values minimize the current ripple and therefore reduce the peak current, which decreases core losses in the inductor and I<sup>2</sup>R losses in the entire power path. However, large inductor values also require more energy storage and more turns of wire, which increase physical size and I<sup>2</sup>R losses in the inductor. Low inductance values decrease the physical size but increase the current ripple and the peak current. Finding the best inductor involves choosing the best compromise between circuit efficiency, inductor size and cost.

Choosing an available inductor value from an appropriate inductor family. Calculating the maximum DC input current at the minimum input voltage  $V_{\text{IN}(\text{MIN})}$  using the following equation.

 $I_{\text{IN}(\text{DC},\text{MAX})} = \frac{I_{\text{A} \vee \text{DD}(\text{MAX})} \times V_{\text{A} \vee \text{DD}}}{V_{\text{IN}(\text{MIN})} \times \eta_{\text{(MIN)}}}$ 

The expected efficiency at that operating point ( $\eta$ MIN) can be taken from an appropriate curve in the Typical Operating Characteristics. Calculating the ripple current at that operating point and the peak current required for the inductor :

$$\begin{split} I_{\text{RIPPLE}} &= \frac{V_{\text{IN}(\text{MIN})} \times (V_{\text{AVDD}} - V_{\text{IN}(\text{MIN})})}{L \times V_{\text{AVDD}} \times f_{\text{OSC}}} \\ I_{\text{PEAK}} &= I_{\text{IN}(\text{DC},\text{MAX})} + \frac{I_{\text{RIPPLE}}}{2} \end{split}$$

The inductor's saturation current rating and the LX over current protection ( $I_{OCP}$ ) should exceed  $I_{PEAK}$  and the inductor DC current rating should exceed  $I_{IN(DC,MAX)}$ . For good efficiency, choosing an inductor with less than 0.1 $\Omega$  series resistance is suggested.

#### **Diode Selection**

To achieve high efficiency, Schottky diode is the recommended diode for lower forward drop voltage and faster switching time. The output diode rating should be large enough for maximum output voltage, average power dissipation and the pulsating diode peak current.

#### **Output Capacitor Selection**

For lower output voltage ripple, the low-ESR ceramic capacitor is recommended. The output voltage ripple consists of two components: one is the pulsating output ripple current flowing through the ESR, and the other is the capacitive ripple caused by charging and discharging.

$$\begin{split} V_{\text{RIPPLE}} &= V_{\text{RIPPLE}\_\text{ESR}} + V_{\text{RIPPLE}\_\text{C}} \\ &\cong I_{\text{PEAK}} \times R_{\text{ESR}} + \frac{I_{\text{PEAK}}}{C_{\text{OUT}}} \left( \frac{V_{\text{AVDD}} - V_{\text{IN}}}{V_{\text{AVDD}} \times f} \right) \end{split}$$

#### Input Capacitor Selection

For better input bypassing, low-ESR ceramic capacitor is recommended for better performance. A  $10\mu$ F input capacitor is sufficient and it is flexible to reduce the value for a lower output power requirement.

#### Gate-High Regulator

The gate-high regulator is to provide the TFT-LCD gate on voltage. The charge pump can provide a programmable output voltage. To regulate the output voltage must set the resistive voltage-divider sensing at FBP pin. The error amplifier varies the difference voltage by sensing FBP pin to regulate the output voltage as the following equation :

 $V_{GH} = V_{FBP}$  (1+R9/R10), where  $V_{FBP} = 1.24V$  (typ.)

Besides, the Schottky diodes with a current rating should equal to or greater than two times of the average chargepump input current. Note that the voltage difference between VGH (VGHM) and AVDD should not exceed 18V.

#### Zener Diode for the Negative Regulator

Bypassing a zener diode(ZD1) after the charge-pump satge can also stablize the negative voltage.

$$V_{GL} = -V_Z$$

V<sub>D</sub>: Zener diode voltage

#### GPM

The GPM is controlled by the frame signals from timing controller to modulate the Gate-On voltage, VGHM, which acts a flicker compensation circuit to reduce the coupling effect between gate lines and pixels. It also can delay the Gate-On voltage while power-on for achieving a correct power-on sequence for gate driver ICs. Both of the poweron delay time and the falling time of the Gate-On voltage are programmable by external capacitor and resistor.





#### **Operational Amplifier**

The function of the operational amplifier is to drive the LCD backplane  $V_{COM}$ . The operational amplifier features +/- 140mA output short circuit current, 12V/µs slew rate, and 12MHz bandwidth. An internal short-circuit protection circuit is implemented to protect the device from output short circuit. The operational amplifier limits the short circuit current while the output is directly shorted.

#### LDO

The low-dropout linear regulator (LDO) can supply up to 350mA current while the input voltage is 3.3V. It uses an internal PMOS as the pass device. The output current limitation is 500mA and It is suitable for the supply voltage to be the T-CONASIC.

#### **Voltage Detector**

The voltage detector monitors the VDIV voltage to generate a reset signal while VDIV is lower than the detecting level and the detecting level is decided by an external resistor divider.  $V_{DET} = V_{DIV} (1+R6/R7) = 1.1V x (1+R6/R7)$ 

 $V_{HYS} = 50 mV (1+R6/R7)$ 

The delay time is programmable by an external capacitor (C10) as equation. For example, setting C10 = 100nF can generate a 12ms delay for reset signal.

 $t_{\rm D} = 120 k \ x \ C10$ 



#### Layout Guideline

For high frequency switching power supplies, the PCB layout is important to get good regulation, high efficiency and stability. The following descriptions are the guidelines for better PCB layout.

- For good regulation, placing the power components as close as possible. The traces should be wide and short enough especially for the high-current output loop.
- The feedback voltage-divider resistors must near the feedback pin. The divider center trace must be shorter and avoid the trace near any switching nodes.
- The compensation circuit should be kept away from the power loops and should be shielded with a ground trace to prevent any noise coupling.
- Minimize the size of the Lx node and keep it wide and shorter. Keep the Lx node away from the FB and analog ground.
- The power ground (PGND) consists of input and output capacitor grounds, the components's ground of charge pump and GPM. The PGND should be wide and short enough to connect to a ground plane.

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- The analog ground (AGND) consists of the grounds of compensation, soft-stat capacitor, FB divider, and OP divider. The AGND should be separated from PGND and connected to the ground of the input capacitor.
- The exposed pad of the chip should be connected to analog ground plane for thermal consideration.



### **Outline Dimension**





#### DETAIL A Pin #1 ID and Tie Bar Mark Options

Note : The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

Symbol		Dimensions I	n Millimeters	Dimensions In Inches		
		Min.	Max.	Min.	Max.	
A		0.800	1.000	0.031	0.039	
	A1	0.000	0.050	0.000	0.002	
A3		0.175	0.250	0.007	0.010	
b		0.180	0.300	0.007	0.012	
D		3.950	4.050	0.156	0.159	
רם	Option 1	2.400	2.500	0.094	0.098	
DZ	Option 2	2.650	2.750	0.104	0.108	
E		3.950	4.050	0.156	0.159	
E2	Option 1	2.400	2.500	0.094	0.098	
	Option 2	2.650	2.750	0.104	0.108	
е		0.500		0.020		
L		0.350	0.450	0.014	0.018	

#### V-Type 24L QFN 4x4 Package

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